

	L #	Hits	Search Text	DBs
1	L1	7454	MEMS or microelectromechanical or micromechanical or (micro adj (mechanical or electromechanical or (electro adj mechanical)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
2	L8	3755	microfabricat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
3	L15	10428	1 8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
4	L22	2347	15 and seal\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
5	L29	220	22 and (plasma with (oxygen or "O.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
6	L36	790	15 and ((plugged plugging seal sealed sealing seals cover covered covering) near15 (hole opening))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
7	L57	12	36 and (dry near3 releas\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
8	L64	17	5258097.URPN.	USPAT
9	L43	86	36 and (plasma with (oxygen or "O.sub.2"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
10	L65	1	"4346963".PN.	USPAT
11	L66	1	"4705360".PN.	USPAT
12	L67	1	"4824215".PN.	USPAT
13	L68	1	"5005951".PN.	USPAT
14	L69	1	"5056893".PN.	USPAT
15	L70	1	"5106197".PN.	USPAT
16	L71	1	"5164853".PN.	USPAT
17	L72	1	"5238435".PN.	USPAT
18	L73	1	"5365356".PN.	USPAT
19	L74	1	"5383040".PN.	USPAT
20	L75	1	"5414545".PN.	USPAT
21	L76	1	"5459597".PN.	USPAT
22	L77	1	"5459598".PN.	USPAT
23	L78	1	"5508134".PN.	USPAT
24	L79	1	"5677749".PN.	USPAT
25	L80	1	"5548429".PN.	USPAT
26	L81	1	"5587817".PN.	USPAT
27	L82	1	"5699138".PN.	USPAT

.	Time Stamp
1	2002/06/14 19:22
2	2002/06/14 19:22
3	2002/06/14 19:23
4	2002/06/14 19:31
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6	2002/06/14 19:33
7	2002/06/14 19:35
8	2002/06/14 19:43
9	2002/06/14 19:49
10	2002/06/14 20:08
11	2002/06/14 20:08
12	2002/06/14 20:08
13	2002/06/14 20:08
14	2002/06/14 20:08
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25	2002/06/14 20:10
26	2002/06/14 20:10
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	L #	Hits	Search Text	DBs
28	L83	1	"5706069".PN.	USPAT
29	L50	139	36 and (dry near3 etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
30	L84	1	"5963788".PN.	USPAT
31	L85	11	5963788.URPN.	USPAT
32	L86	1	"5814554".PN.	USPAT
33	L87	1	"5798283".PN.	USPAT
34	L88	1	"5550090".PN.	USPAT
35	L89	1	"5504026".PN.	USPAT
36	L90	1	"5493177".PN.	USPAT
37	L91	496	(sandia adj corporation).asn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
38	L98	41	91 and ((remov\$3 etch\$3) near5 sacrificial)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
39	L10 5	32	98 and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
40	L11 2	1872	((remov\$3 etch\$3) near5 sacrificial) same (hole opening channel)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
41	L11 9	433	15 and 112	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
42	L12 6	1128	((remov\$3 etch\$3) near5 sacrificial) near20 (hole opening channel)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
43	L13 3	312	15 and 126	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
44	L14 0	109	126 same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
45	L14 7	38	15 and 140	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
46	L15 4	118	126 same (gas vapor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
47	L16 1	37	15 and 154	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
48	L16 8	6	"5834333"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Time Stamp
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36	2002/06/14 20:32
37	2002/06/14 20:41
38	2002/06/14 20:57
39	2002/06/14 20:42
40	2002/06/14 20:59
41	2002/06/14 20:59
42	2002/06/14 20:59
43	2002/06/14 21:00
44	2002/06/14 21:06
45	2002/06/14 21:00
46	2002/06/14 21:07
47	2002/06/14 21:30
48	2002/06/14 21:30